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## \*BIBDATASHEET\*

Bib Data Sheet

## **CONFIRMATION NO. 7685**

| SERIAL NUMB<br>10/639,580  | ER   | FILING DATE<br>08/13/2003<br>RULE                   |  |  | GROUP ART UNIT<br>2825 |                         | ATTORNEY<br>DOCKET NO.<br>8008-1045 |  |             |  |
|--|--|---|--|--|------------------------|-------------------------|-------------------------------------|--|-------------|--|
| APPLICANTS   |  |   |  |  |                        |                         |                                     |  |             |  |
| Masanao Horie, Kanagawa, JAPAN;  |  |   |  |  |                        |                         |                                     |  |             |  |
| ** CONTINUING DATA **********************************  |  |   |  |  |                        |                         |                                     |  |             |  |
| ** FOREIGN APPLICATIONS ************************************   |  |   |  |  |                        |                         |                                     |  |             |  |
| IF REQUIRED, FOREIGN FILING LICENSE GRANTED ** 11/08/2003  |  |   |  |  |                        |                         |                                     |  |             |  |
| 35 USC 119 (a-d) conditions ves I no Met after   |  |   |  |  |                        | HEETS                   | TOTAL                               |  | INDEPENDENT |  |
| Allowance ,  |  |   |  |  |                        | AWING<br>23             | CLAIMS<br>8                         |  | CLAIMS<br>1 |  |
| ADDRESS<br>000466<br>YOUNG & THOMPSON<br>745 SOUTH 23RD STREET<br>2ND FLOOR<br>ARLINGTON , VA<br>22202 |  |   |  |  |                        |                         |                                     |  |             |  |
| TITLE<br>Fabrication method for a semiconductor CSP type package                                       |  |   |  |  |                        |                         |                                     |  |             |  |
|  |  |   |  |  |                        | All Fees                |                                     |  |             |  |
| FILING FEE   | FEES: Authority has been given in Paper 1.16 Fees ( Filing )  1.17 Fees ( Processing Ext. of |   |  |  |                        |                         |                                     |  |             |  |
| RECEIVED   | No<br>No   | o to charge/credit DEPOSIT ACCOUNT o for following: |  |  |                        |                         | time )                              |  |             |  |
| 750  |  |   |  |  |                        | 1.18 Fees (Issue) Other |                                     |  |             |  |
|  |  |   |  |  |                        |                         | Credit                              |  |             |  |